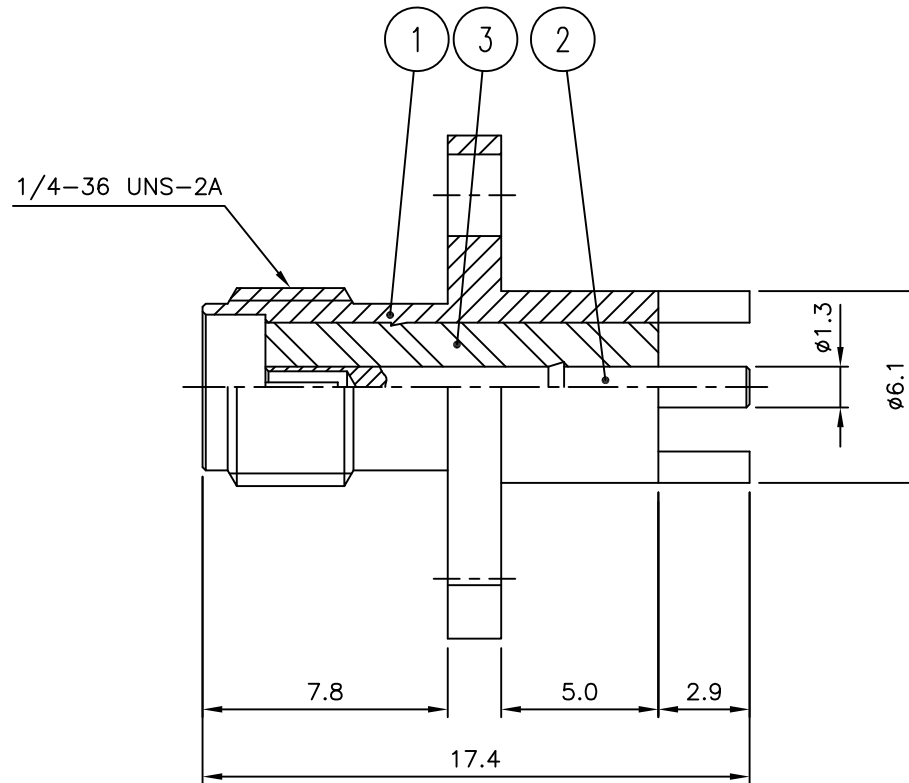
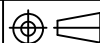


REVISION					
REV	DESCRIPTION	DRAWN	APPR	DATE	
IR	Initial Registration	I.C.KIM		2020. 01. 13.	
1	절연체 공용화로 인한 코드 변경	S.Y.EUN	I.C.KIM	2020. 12. 23.	



1	3	INSULATOR	1	TEFLON		DIN02077-N/1 DIN00088-N/1
	2	CONTACT	1	BeCu C17300	Gold Plate	DCT00235-5/1
	1	BODY	1	MBsBD C3604BD-F	Nickel Plate (납땜성 향상)	DBD00354-5/2
	NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal ±0.2	DATE 2020. 12. 23.			 COMTECH KJ COMTECH CO.,LTD. RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017	
	Angle ±1°	APPROVED BY I.C.KIM				
MATERIAL _____		CHECKED BY	TITLE SMA50 SOLDER END JS-2H-2R			
		DRAWN BY S.Y.EUN				
FINISH _____	SCALE 4/1	UNIT mm		A4	DWG NO. CN00974-7/2	
					REVISION 1	SHEET 1 of 1